



NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE6020A uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

- V_{DS} =60V,I_D =20A
 R_{DS(ON)} <25mΩ @ V_{GS}=10V
 R_{DS(ON)} <31mΩ @ V_{GS}=4.5V
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔVds TESTED!

Schematic diagram

(2) D

(3) s

(1) GO

TO-220-3L top view

G

Package Marking and Ordering Information

| Device Marking | Device | Device Package | Reel Size | Tape width | Quantity |
|----------------|----------|----------------|-----------|------------|----------|
| NCE6020A | NCE6020A | TO-220-3L | - | - | - |

Absolute Maximum Ratings (Tc=25°Cunless otherwise noted)

| Parameter | Symbol | Limit | Unit |
|--|-----------------------|------------|------|
| Drain-Source Voltage | VDS | 60 | V |
| Gate-Source Voltage | Vgs | ±20 | V |
| Drain Current-Continuous | Ι _D | 20 | A |
| Drain Current-Continuous(Tc=100 ℃) | I _D (100℃) | 14 | A |
| Pulsed Drain Current | Ідм | 60 | А |
| Maximum Power Dissipation | PD | 45 | W |
| Derating factor | | 0.3 | W/°C |
| Single pulse avalanche energy (Note 5) | E _{AS} | 72 | mJ |
| Operating Junction and Storage Temperature Range | TJ,TSTG | -55 To 175 | °C |



Pb Free Product



Thermal Characteristic

| Thermal Resistance, Junction-to-Case ^(Note 2) | Rejc | 3.3 | °C/W |
|--|------|-----|------|
|--|------|-----|------|

Electrical Characteristics (Tc=25°C unless otherwise noted)

| Parameter | Symbol | Condition | Min | Тур | Max | Unit | |
|------------------------------------|---------------------|---|-----|-------|------|----------|--|
| Off Characteristics | I | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} =0V I _D =250µA | | - | - | V | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =60V,V _{GS} =0V | - | - | 1 | μA | |
| Gate-Body Leakage Current | I _{GSS} | V _{GS} =±20V,V _{DS} =0V | - | - | ±100 | nA | |
| On Characteristics (Note 3) | | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | V _{DS} =V _{GS} ,I _D =250µA | 1.2 | 1.6 | 2.5 | V | |
| | P | V _{GS} =10V, I _D =20A | - | 21 | 25 | mΩ | |
| Drain-Source On-State Resistance | R _{DS(ON)} | V _{GS} =4.5V, I _D =20A | | 25.5 | 31 | | |
| Forward Transconductance | G FS | V _{DS} =5V,I _D =5A | 11 | - | - | S | |
| Dynamic Characteristics (Note4) | | | | | | | |
| Input Capacitance | C _{lss} | | - | 973.2 | - | PF | |
| Output Capacitance | Coss | V_{DS} =30V, V_{GS} =0V, | - | 61.2 | - | PF | |
| Reverse Transfer Capacitance | Crss | F=1.0MHz | - | 58.8 | - | PF | |
| Switching Characteristics (Note 4) | · | | | | | | |
| Turn-on Delay Time | t _{d(on)} | | - | 5 | - | nS | |
| Turn-on Rise Time | tr | V _{DD} =30V,I _D =2A,R _L =6.7Ω | - | 2.6 | - | nS | |
| Turn-Off Delay Time | t _{d(off)} | V _{GS} =10V,R _G =3Ω | - | 16.1 | - | nS | |
| Turn-Off Fall Time | t _f | | - | 2.3 | - | nS | |
| Total Gate Charge | Qg | | - | 25 | | nC | |
| Gate-Source Charge | Q _{gs} | $V_{DS}=30V, I_{D}=4.5A,$ | - | 4.5 | | nC | |
| Gate-Drain Charge | Q _{gd} | V _{GS} =10V | - | 6.5 | | nC | |
| Drain-Source Diode Characteristics | I | | | | | | |
| Diode Forward Voltage (Note 3) | V _{SD} | V _{GS} =0V,I _S =20A | - | | 1.2 | V | |
| Diode Forward Current (Note 2) | Is | | - | - | 20 | Α | |
| Reverse Recovery Time | t _{rr} | TJ = 25°C, IF =20A | - | 29 | - | nS | |
| Reverse Recovery Charge | Qrr | di/dt = 100A/µs ^(Note3) | - | 49 | - | nC | |
| Forward Turn-On Time | ton | Intrinsic turn-on time is negligible (turn-on is dominated by LS+LE | | | | y LS+LD) | |

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, $t \le 10$ sec.

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

4. Guaranteed by design, not subject to production

5. EAS condition:Tj=25 $^\circ\mathrm{C}$,VDD=30V,VG=10V,L=0.5mH,Rg=25 Ω

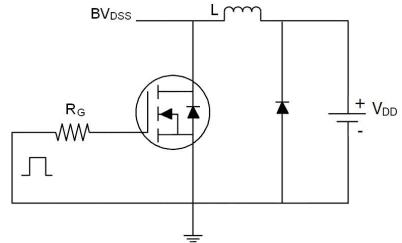


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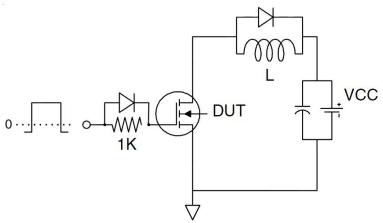




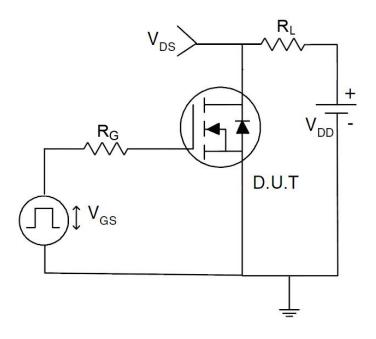
Test Circuit 1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit

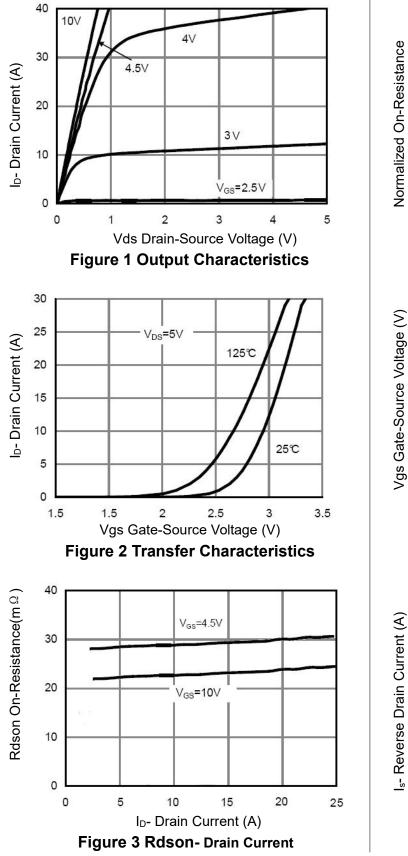


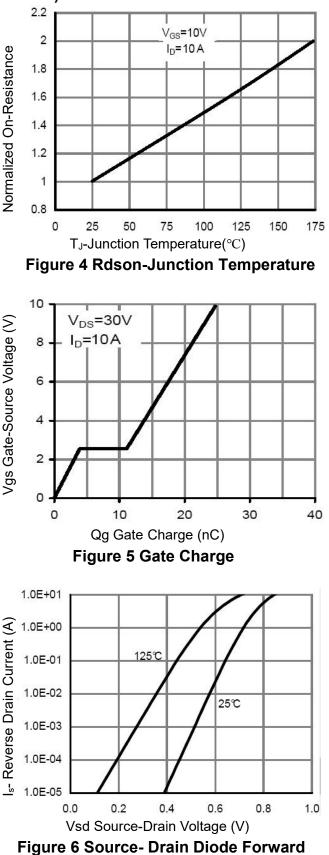














1.0

0.1

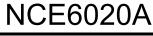
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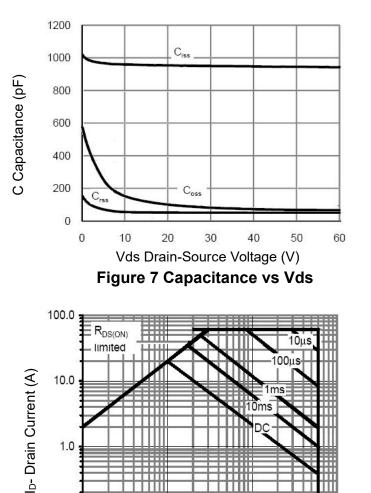
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100







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Vds Drain-Source Voltage (V)

Figure 8 Safe Operation Area

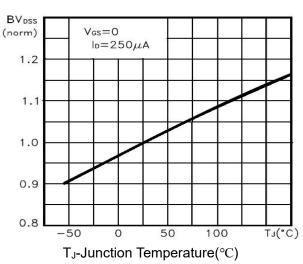


Figure 9 BV_{DSS} vs Junction Temperature

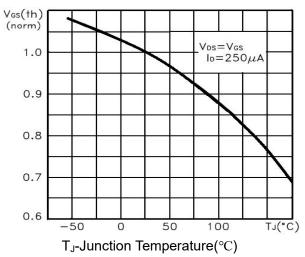
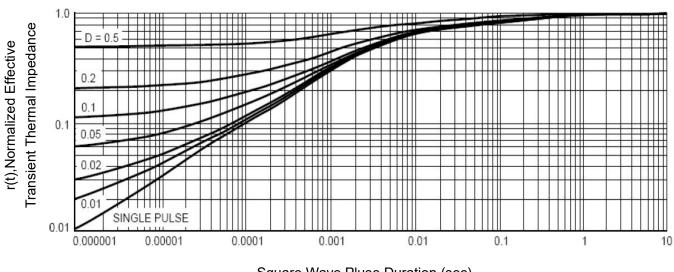


Figure 10 V_{GS(th)} vs Junction Temperature



Square Wave Pluse Duration (sec) Figure 11 Normalized Maximum Transient Thermal Impedance

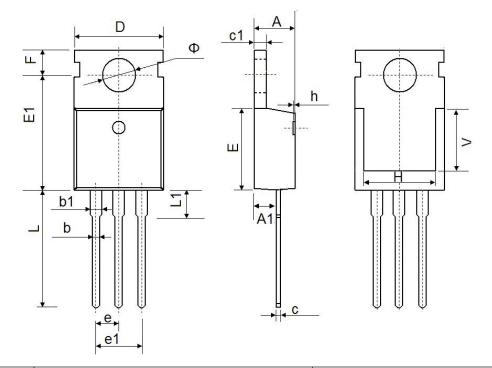


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NCE6020A

TO-220-3L Package Information



| Symbol | Dimensions | In Millimeters | Dimensions In Inches | | |
|--------|------------|----------------|----------------------|-------|--|
| Symbol | Min. | Max. | Min. | Max. | |
| A | 4.400 | 4.600 | 0.173 | 0.181 | |
| A1 | 2.250 | 2.550 | 0.089 | 0.100 | |
| b | 0.710 | 0.910 | 0.028 | 0.036 | |
| b1 | 1.170 | 1.370 | 0.046 | 0.054 | |
| С | 0.330 | 0.650 | 0.013 | 0.026 | |
| c1 | 1.200 | 1.400 | 0.047 | 0.055 | |
| D | 9.910 | 10.250 | 0.390 | 0.404 | |
| E | 8.9500 | 9.750 | 0.352 | 0.384 | |
| E1 | 12.650 | 12.950 | 0.498 | 0.510 | |
| e | 2.540 | TYP. | 0.100 TYP. | | |
| e1 | 4.980 | 5.180 | 0.196 | 0.204 | |
| F | 2.650 | 2.950 | 0.104 | 0.116 | |
| Н | 7.900 | 8.100 | 0.311 | 0.319 | |
| h | 0.000 | 0.300 | 0.000 | 0.012 | |
| L | 12.900 | 13.400 | 0.508 | 0.528 | |
| L1 | 2.850 | 3.250 | 0.112 | 0.128 | |
| V | 7.500 REF. | | 0.295 REF. | | |
| Ф | 3.400 | 3.800 | 0.134 | 0.150 | |







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